

Discussion Input from DESY

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07.05.204 - Vertex Detector Discussion

HELMHOLTZ



Recap Requirements

Lepton collider

- Challenging requirements for future lepton collider
 - Low mass → low power and gas cooling
 - Good timing → fast shaping → higher power
 - Point resolution → small pixels/charge sharing → high number of channels → higher power
- Can we have it all in one?

	HL-LHC	Lepton collider
x/X ₀	10 %	<1 %
Time resolution	25 ns	< ns
Pitch	50 µm	< 25 µm
Point resolution	15 µm	3 µm
n _{eq} / cm ²	10 ¹⁶	1011

Where do we stand

Summary from yesterday and a bit beyond

Simulations

AllPix2 +TCAD toolkit

- → Optimization
- → Validated with data
- → still a few open questions
- → Transient studies
- → N-Gap seems to be required for us at the moment

Design

CSA+Krummenacher

- →Fully functional
- → Relatively large
- → Fast
- → ~35e noise

H₂M

- → Multi purpose chip
- → digital-on-top
- → Fully functional
- → ~70e noise

Testing

DAQ

→ Caribou

Laboratory

- →Fe55
- → Signal injection
- \rightarrow TCT
- → X-ray (Uni HH)

Testbeam

- → 1-6 GeV e-
- → EUDAQ2 integration
- → Corry reco
- →APTS,MLR1 & H2M

Integration

Building large detectors

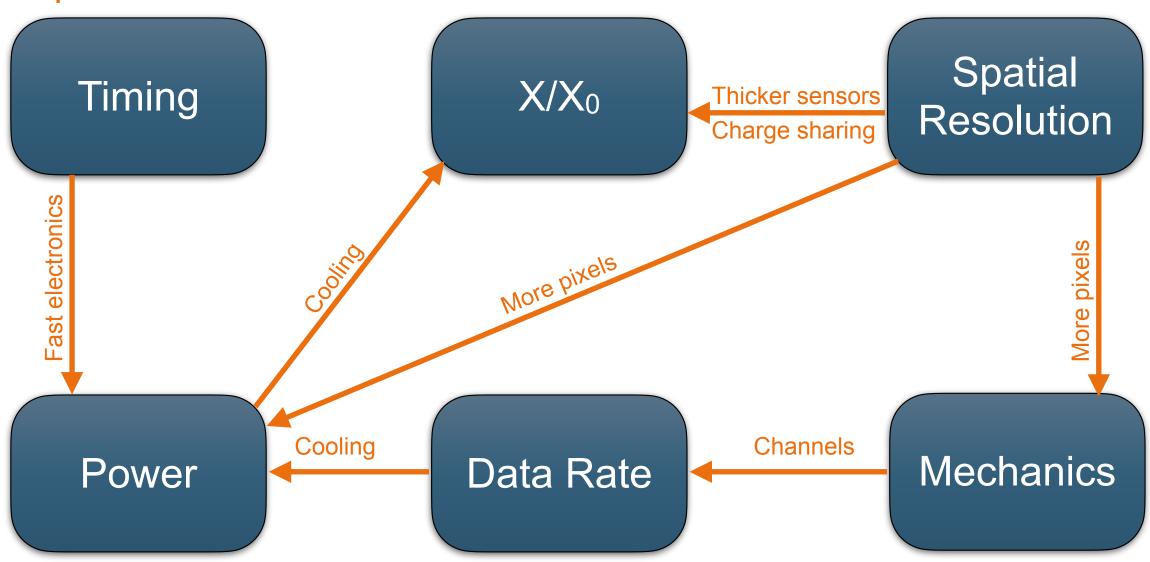
- → Huge cleanrooms
- → ATLAS/CMS endcaps
- → Light mechanics
- → Two phase CO₂ cooling

Future vertex detectors

- → Light mechanics
- → Microchannel cooling?
- → Silicon photonics
- →

Challenges

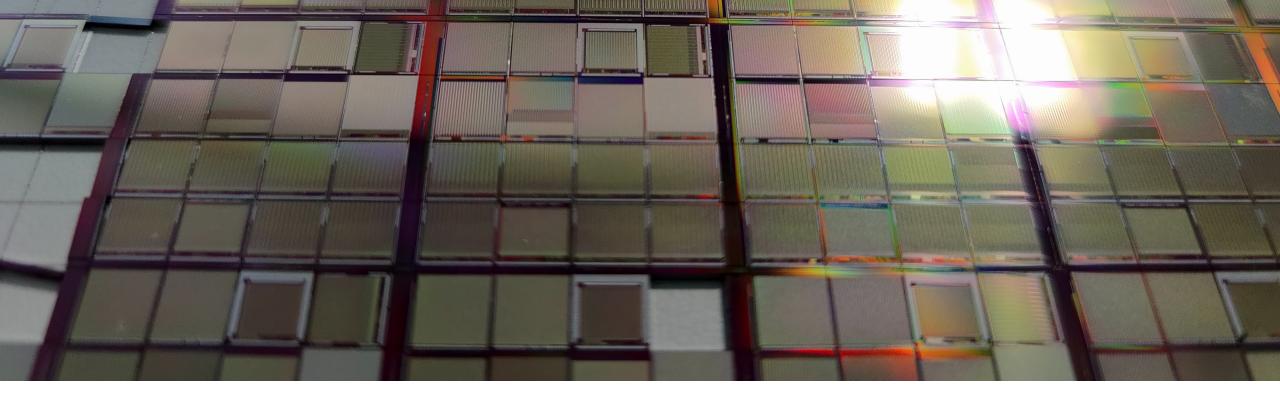
Simplified overview



The future?

Where can we go and what could we sacrifice - not conclusive, should trigger discussions

- (Single) high power plane for timing
 - One close to vertex? → bad in terms of material, good in terms of timing
 - Can we afford more?
- Need for stitching? Overlap of ca 25-40um thick sensor still okay? → simulations
- Variable pixel pitch → interconnecting pixels to reduce data output in outer layers?
- Light mechanics, Kapton support, He/Air cooling folds? micro channel cooling in MAPS bulk material?
- Silicon photonics for readout?
- What could be the mid-term application of these developments?
- We would like to contribute on all topics from design to construction but need to secure funding for it.



Contact

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